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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: Beaman et al.

Date: March 19, 2004

Serial Number: 08/756,830

Group Art Unit: 2858

Filed: November 20, 1996

Examiner: V. Nguyen

For: A HIGH DENSITY INTEGRAL TEST PROBE  
AND FABRICATION METHOD

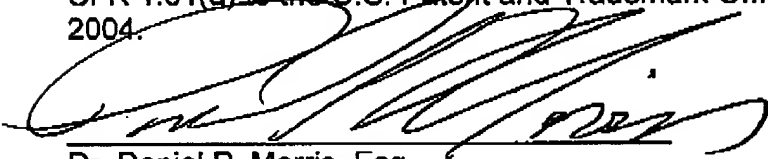
Docket No.: YOR919950023US2

**OFFICIAL**Commissioner for Patents  
PO Box 1450  
Alexandria, VA 22313-1450**RECEIVED**

MAR 29 2004

**OFFICE OF PETITIONS****CERTIFICATE OF FACSIMILE TRANSMISSION**

I hereby certify that this paper (2 pages) is being facsimile transmitted under Rule 37 CFR 1.61(d) to the U.S. Patent and Trademark Office to (703) 308-6916 on March 19, 2004.

  
Dr. Daniel P. Morris, Esq.  
Reg. No. 32,053**ATTN.: DEREK WOODS****PETITION FOR CORRECTED FILING RECEIPT AND REQUEST  
FOR CORRECTION OF THE CLAIM OF PRIORITY UNDER 37 CFR 1.78**

Applicants petition to correct the filing receipt of the above-identified application to read as follows:

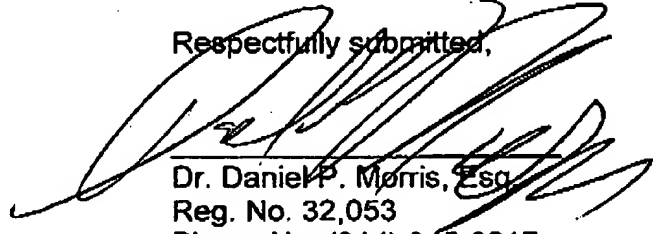
--This application is a continuation of US Application 08/425,543 filed on 04/20/1995 now abandoned which is a continuation in part of US Application 08/300620 filed on 02-Sep-1994 now US patent 5531022 issued on 02-Jul-1996 which is a division of US Application 07/963346 filed on 19-Oct-1992 now US patent 5371654 issued on 06-Dec-1994.--

Serial No. 08/756,830

Page 1 of 2

Please charge deposit account 09-0468 any fee necessary to enter this paper. Since this application was filed before November 29, 2000, no fee should be necessary to enter this paper.

Respectfully submitted,



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